

# **UP SuperServer SYS-521E-WR**

2U UP WIO with 8 hot-swap 3.5" SAS/SATA (4 NVMe hybrid) bays and up to 5 PCIe 5.0 slots



### **Key Applications**

Data Center Optimized, Network Appliance, Database/Storage, Entry GPU

### **Key Features**

- Single Socket E (LGA-4677) 4th/5th Gen Intel® Xeon® Scalable processors. Up to 300W TDP;
- Intel® C741 Chipset;
- 8 DIMMs; Supports 3DS DDR5 RDIMM. Up to 5600 MHz;
- Onboard 1G LAN ports (Intel® i210), 1 dedicated IPMI LAN;
- 8x front hot-swap 3.5" SATA3 drive bays (Optional 4 hybrid Gen5 NVMe), SAS3 with additional SAS controller card;



Redundant Now Titanium 1000W Power Supplies;	
Form Factor	2U Rackmount
	Enclosure: 437 x 89 x 647mm (17.2" x 3.5" x 25.5")
	Package: 673.1 x 279.4 x 863.6mm (26.5" x 11" x 34")
Processor	Single Socket E (LGA-4677)
	5th Gen Intel® Xeon® / 4th Gen Intel® Xeon® Scalable processors
	Up to 52C/104T; Up to 300MB Cache
GPU	Max GPU Count: Up to 1 double-width or 2 single-width GPUs
	Supported GPU: NVIDIA PCIe: T400, RTX A6000, RTX A5000, RTX A4500, RTX A4000, RTX A2000
	CPU-GPU Interconnect: PCIe 5.0 x16 CPU-to-GPU Interconnect
System Memory	Slot Count: 8 DIMM slots/8 Channels
	Max Memory (1DPC): Up to 2TB 5600MT/s ECC DDR5 RDIMM
Drive Bays Configuration	Default: Total 8 bays
	<ul> <li>4 front hot-swap 3.5" SAS*/SATA drive bays</li> </ul>
	<ul> <li>4 front hot-swap 3.5" PCIe 5.0 NVMe*/SAS*/SATA drive bays</li> </ul>
	(*NVMe/SAS support may require additional storage controller and/or cables)
	M.2: 1 M.2 PCIe 3.0 x2 NVMe slot (M-key 2280/22110)
	Peripheral Bays: 2 2.5" bays (optional)
Expansion Slots	Default

# **Expansion Slots**

- 2 PCIe 5.0 x16 FHFL double-width slots
- 2 PCIe 5.0 x8 LP slots

### Option A\*

- 1 PCIe 5.0 x16 FHFL double-width slot
- 2 PCIe 5.0 x8 FHFL slots
- 2 PCIe 5.0 x8 LP slots

### **On-Board Devices**

SATA: SATA (6Gbps); RAID 0/1/5/10 support

NVMe: NVMe; RAID 0/1/5/10 support(Intel® VROC RAID key required)

Chipset: Intel® C741

Network Connectivity: 2 RJ45 1GbE with Intel® I210

## Input / Output

LAN: 2 RJ45 1 GbE LAN ports

1 RJ45 1 GbE Dedicated BMC LAN port (IPMI shared on LAN port 1)

USB: 2 USB 3.2 Gen1 Type-A ports(rear) 2 USB 2.0 Type-A ports(rear) 1 USB 2.0 Type-A port(Header) 2 USB 3.2 Gen1 ports(Header)

Video: 1 VGA port Serial: 1 COM port(Rear) 1 COM port(Header) TPM: 1 TPM header



Power Button
Sim DVD Modale (Optional) Status LEDs

Pull-out Tag

Drive Bay

Description

1 83.35 Het-saws SASS/SASA3 Dove Bays

\* NVMe or SAS3 support requires additional parts from the optional parts list

(Front View - System)

Redunder 1000W Transum 2.2.5 Med. Joseph Level Power Supplies SATAS Drive Bays (Optional)

Serial Port

Power Says PFFFF

Power Says PFFF

Power Says PFFFF

Power Says PFFF

Power

(Rear View - System)

System Cooling	Fans: 3 heavy duty PWM 80x80x38mm Fan(s) Air Shroud: 1 Air Shroud
	Air Shroud: 1 Air Shroud
Power Supply	2x 1000W Redundant (1 + 1) Titanium Level (96%) power supplies
System BIOS	BIOS Type: AMI 32MB SPI Flash EEPROM
Management	SuperCloud Composer®; Supermicro Server Manager (SSM); Supermicro Update Manager (SUM); Supermicro
	SuperDoctor® 5 (SD5); Super Diagnostics Offline (SDO); Supermicro Thin-Agent Service (TAS); SuperServer
	Automation Assistant (SAA) New!
PC Health Monitoring	CPU: Monitors for CPU Cores, Chipset Voltages, Memory
	8 Phase-switching voltage regulator
	FAN: Fans with tachometer monitoring
	Status monitor for speed control
	Pulse Width Modulated (PWM) fan connectors
	Temperature: Monitoring for CPU and chassis environment
	Thermal Control for fan connectors
Dimensions and Weight	Weight: Gross Weight: 59 lbs (26.76 kg)
	Net Weight: 34 lbs (15.42 kg)
	Available Color: Black
Operating Environment	Operating Temperature: 10°C to 35°C (50°F to 95°F)
	Non-operating Temperature: -30°C to 60°C (-22°F to 140°F)
	Operating Relative Humidity: 8% to 80% (non-condensing)
	Non-operating Relative Humidity: 8% to 90% (non-condensing)
Motherboard	Super X13SEW-F
Chassis	CSE-825B2TS-R0WNP